

Infineon Ref No. 14.128
 MMB Ref No. 1890-0395

**DECLARATION FOR PATENT APPLICATION, POWER OF
 ATTORNEY & DESIGNATION OF CORRESPONDENCE ADDRESS**

As below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**SEMICONDUCTOR COMPONENT COMPRISING A TEMPORARY FIELD STOPPING AREA,
 AND METHOD FOR THE PRODUCTION THEREOF**

the specification of which (check one)

_____ is attached hereto.

was filed on January 24, 2005 as Application Serial No. PCT/DC2005/000093 and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information known to me to be material to the patentability of this application in accordance with 37 CFR §1.56(a).

PRIOR FOREIGN/PCT APPLICATION(S) FILED WITHIN 12 MONTHS (6 MONTHS FOR DESIGN) PRIOR TO THIS APPLICATION AND ANY PRIORITY CLAIMS UNDER 35 U.S.C. § 119(a)-(d)

I hereby claim foreign priority benefits under 35 USC § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
Number	Country	Day/Month/Year Filed	Yes	No
10 2004 004 45.1	Germany	27 January 2004	X	

**CLAIM FOR BENEFIT OF PRIOR U.S. PROVISIONAL APPLICATION(S)
 (35 U.S.C. § 119(e))**

I hereby claim the benefit under Title 35, United States Code, § 119 (e) of any United States provisional application(s) listed below:

Provisional Application Number	Filing Date

**CLAIM FOR BENEFIT OF EARLIER US/PCT APPLICATION(S)
UNDER 35 U.S.C. § 120**

I hereby claim the benefits under 35 USC § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 USC § 112, I acknowledge the duty to disclose material information as defined in 37 CFR § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Appl. No.	Filing Date	Patented, Pending, Abandoned

Power of Attorney: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

Harold C. Moore, Reg. No. 37,892, Paul J. Maginot, Reg. No. 34,984, Michael D. Beck, Reg. No. 32,722, David M. Lockman, Reg. No. 34,214, Russell E. Fowler, Reg. No. 43,615, and Jim D. Wood, Reg. No. 43,285.

Send correspondence to:

Harold C. Moore
Maginot, Moore & Beck
Chase Tower
111 Monument Circle, Suite 3250
Indianapolis, Indiana 46204

Direct telephone calls to:

Harold C. Moore
Telephone: (317) 638-2922
Facsimile: (317) 638-2139

I hereby declare that all statements made herein on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under

18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of First Inventor: Hans-Joachim Schulze	
Inventor's Signature: <i>Hans-Joachim Schulze</i>	Date: 4.9.06
Residence: Ottostr. 60f, 85521 Ottobrunn, Germany	
Citizenship: Germany	
Mailing Address: Ottostr. 60f, 85521 Ottobrunn, Germany	

Full Name of First Inventor: Josef Lutz	
Inventor's Signature:	Date:
Residence: Wartburgstr. 16b., 09126 Chemnitz, Germany	
Citizenship: Germany	
Mailing Address: Wartburgstr. 16b., 09126 Chemnitz, Germany	

I hereby declare that all statements made herein on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under

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Full Name of First Inventor: Hans-Joachim Schulze	
Inventor's Signature:	Date:
Residence: Ottostr. 60f, 85521 Ottobrunn, Germany	
Citizenship: Germany	
Mailing Address: Ottostr. 60f, 85521 Ottobrunn, Germany	

Full Name of First Inventor: Josef Lutz	
Inventor's Signature: 	Date: Aug 22, 2006
Residence: Wartburgstr. 16b., 09126 Chemnitz, Germany	
Citizenship: Germany	
Mailing Address: Wartburgstr. 16b., 09126 Chemnitz, Germany	

RECORDATION FORM COVER SHEET
PATENTS ONLY

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Hans-Joachim Schulze
Josef Lutz

2. Name and address of receiving party(ies):

Name: Infineon Technologies AG
Street Address: St. -Martin-Strasse 53
City: 81669 Munich
Country: Germany

Additional name(s) of conveying party(ies) attached? [] Yes [X] No

Additional name(s) & address(es) attached? [] Yes [X] No

3. Nature of Conveyance:

[X] Assignment [] Merger
 [] Security Agreement [] Change of Name
 [] Other _____

Execution Date(s): 09/04/2006; 08/22/2006

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is

A. Patent Application No(s) 10/587,413

B. Patent No(s)

Additional numbers attached? [] Yes [X] No

Title of Invention: Semiconductor Component Comprising a Temporary Field Stopping Area, and Method for the Production Thereof

Our Docket No.: 1890-0395

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Harold C. MooreInternal Address: Maginot, Moore & Beck

Street Address: 111 Monument Circle, Suite 3250
 City: State: Zip: Indianapolis, IN 46204-5109

GH 00000099 105874136. Total number of applications and patents involved
17. Total fee (37 CFR 3.41): \$.40.00

[X] Enclosed
 [] Authorized to be charged to deposit account

8. Deposit Account number: 13-0014

(Attach duplicate copy of this page if paying by deposit account)

40.00 0P

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Harold C. MooreName of Person Signing
Registration No. 37,892

Signature

June 5, 2007

Date

Total number of pages including cover sheet, attachments and document 3

Mail documents to be recorded with required cover sheet information to:
 Mail Stop Assignment Recordation Services, Commissioner for Patents
 P.O. Box 1450, Alexandria, VA 22313-1450

06/11/2007 MKAYP

02 FC:8021

INFINEON REF NO. 14.128
MMB REF NO. 1890-0395**ASSIGNMENT**

For good and valuable consideration, I, Hans-Joachim Schulze, a citizen of Germany, residing at Ottostr. 60f, 85521 Ottobrunn, Germany, and Josef Lutz, a citizen of Germany, residing at Wartburgstr. 16b, 09126 Chemnitz, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81669, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, Serial No. 10/587,413, filed on July 27, 2006 and

entitled: **SEMICONDUCTOR COMPONENT COMPRISING A TEMPORARY FIELD
STOPPING AREA, AND METHOD FOR THE PRODUCTION THEREOF**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:

DATE: 4.9.06

NAME: Hans-Joachim Schulze

SIGNATURE:

DATE: _____

NAME: Josef Lutz

INFINEON REF NO. 14.128
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ASSIGNMENT

For good and valuable consideration, I, Hans-Joachim Schulze, a citizen of Germany, residing at Ottostr. 60f, 85521 Ottobrunn, Germany, and Josef Lutz, a citizen of Germany, residing at Wartburgstr. 16b, 09126 Chemnitz, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81669, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, Serial No. 10/587,413, filed on July 27, 2006 and

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and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: _____

DATE: _____

NAME: Hans-Joachim Schulze

SIGNATURE: _____

DATE: Aug 22, 2006

NAME: Josef Lutz